



N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$ $I_{D}\left(A\right)$			
60	0.011 at V _{GS} = 10 V	12.7		
	0.013 at V _{GS} = 6.0 V	11.7		

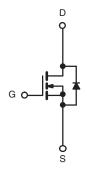
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFETs
- 175 °C Maximum Junction Temperature
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

· Primary Side Switch



N-Channel MOSFET

		SO-8		
S	1		8	D
S	2		7	D
S	3		6	D
G	4		5	D
			•	

Top View

Ordering Information: Si4470EY-T1-E3 (Lead (Pb)-free)

Si4470EY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 ^{\circ}C$, unle	ess otherwise	noted)		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	60		V
Gate-Source Voltage		V_{GS}	± 20		
Continuous Dunin Comment /T 450 °C)	T _A = 25 °C	- I _D	12.7	9.0	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		10.6	7.5	
Pulsed Drain Current		I _{DM}	50		Α
Avalanche Current	L = 0.1 mH	I _{AS}	50		
Continuous Source Current (Diode Conduction) ^a		I _S	3.1	1.5	
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	3.75	3.75 1.85	
	T _A = 70 °C	ı D	2.6	1.3	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175		°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manifestor Localitan to Applicant	t ≤ 10 s	R _{thJA}	33	40	°C/W	
Maximum Junction-to-Ambient ^a	Steady State	' 'thJA	65	80		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	17	21		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

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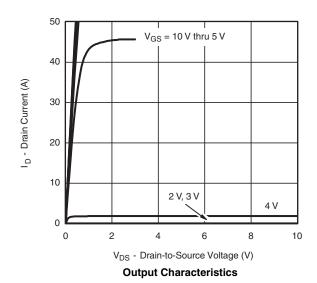
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	<u> </u>					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.0			V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	$_{OS} = 0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$ ± 100		± 100	nA
Zana Oata Valla va Busin Oamani		V _{DS} = 48 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			5	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$				Α
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 12 A		0.009	0.011	Ω
	R _{DS(on)}	$V_{GS} = 6.0 \text{ V}, I_D = 10 \text{ A}$		0.0105	0.013	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		50		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 3.0 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.2	V
Dynamic ^b	•			•		
Total Gate Charge	Qg			46	70	nC
Gate-Source Charge	Q_{gs}			11.5		
Gate-Drain Charge	Q_{gd}			11.5		
Gate Resistance	R_{g}		0.25	0.85	1.4	Ω
Turn-On Delay Time	t _{d(on)}			16	25	
Rise Time	t _r	V_{DD} = 30 V, R_L = 30 Ω		12	18	
Turn-Off Delay Time	$t_{d(off)}$ $I_{D} \cong 1.0 \text{ A, } V_{GEN} = 10 \text{ V, } R_{g} = 6 \text{ C}$	$I_D\cong$ 1.0 A, V_{GEN} = 10 V, R_g = 6 Ω		50	75	ns
Fall Time	t _f			30	45	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3.0 A, dI/dt = 100 A/μs		40	60	

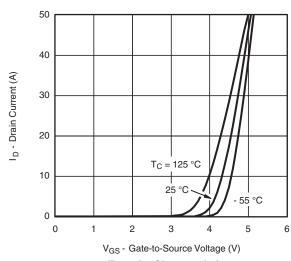
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

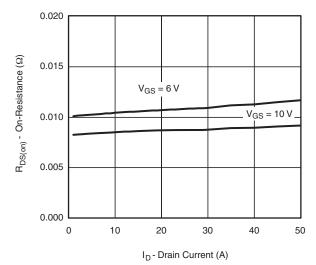




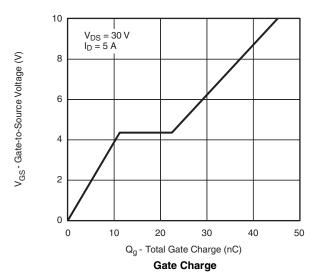


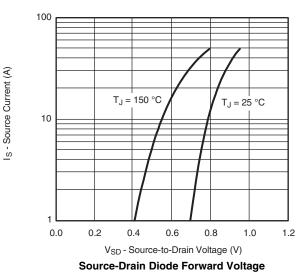


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



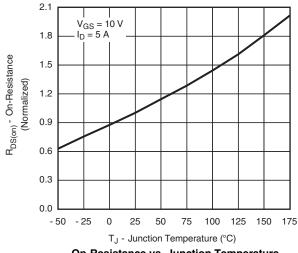
On-Resistance vs. Drain Current



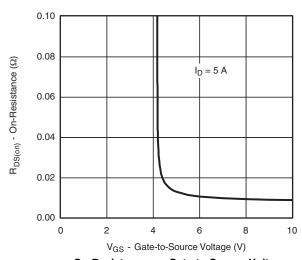


4000 3500 C_{iss} 3000 C - Capacitance (pF) 2500 2000 1500 1000 Coss 500 0 15 45 60

V_{DS} - Drain-to-Source Voltage (V) Capacitance



On-Resistance vs. Junction Temperature

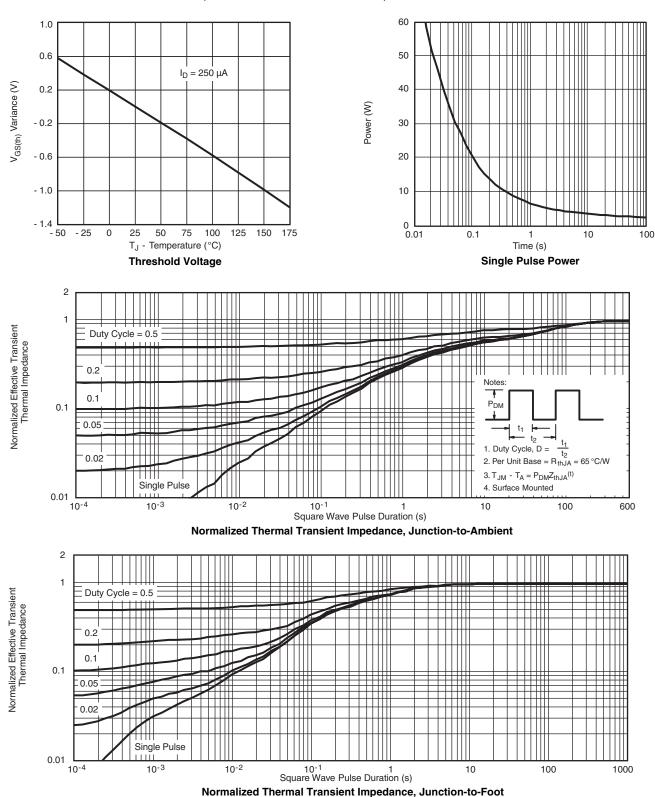


On-Resistance vs. Gate-to-Source Voltage

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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